

Parameter	Ratings	Units
Blocking Voltage	60	V _P
Load Current	150	mA
Max R _{ON}	16	Ω
LED Current to Operate	1	mA

Features

- Low Drive Power Requirements (TTL/CMOS Compatible)
- Arc-Free With No Snubbing Circuits
- 3750V_{rms} Input/Output Isolation
- FCC Compatible
- VDE Compatible
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- Surface Mount Tape & Reel Version Available

Applications

- Security
 - Passive Infrared Detectors (PIR)
 - Data Signaling
 - Sensor Circuitry
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
 - Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

Clare's XAA117 is a dual 1-Form-A Solid State Relay that has two independently controlled, optically coupled MOSFET switches.

The MOSFET switches and photovoltaic die use Clare's patented OptoMOS[®] architecture to provide 3750 V_{rms} of input-to-output isolation. The optically coupled output is controlled by a highly efficient GaAIAs infrared LED.

This dual single-pole OptoMOS relay provides a more compact design solution than discrete single-pole relays in a variety of applications, and saves board space by incorporating both switches in a single 8-Pin package.

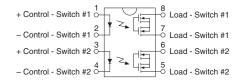
Approvals

- UL Recognized: File Number E76270
- CSA Certified: File Number LR 43639-10

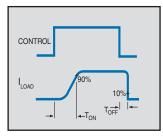
Ordering Information

Part #	Description
XAA117	8-Pin DIP (50/Tube)
XAA117S	8-Pin Surface Mount (50/Tube)
XAA117STR	8-Pin Surface Mount (1,000/Reel)
XAA117P	8-Pin Flat Pack (50/Tube)
XAA117PTR	8-Pin Flat Pack (1,000/Reel)

Pin Configuration



Switching Characteristics of Normally Open (Form A) Devices







Absolute Maximum Ratings

Parameter	Ratings	Units	
Blocking Voltage	60	V _P	
Reverse Input Voltage	5	V	
Input Control Current	50	mA	
Peak (10ms)	1	А	
Input Power Dissipation ¹	150	mW	
Total Power Dissipation ²	800	mW	
Isolation Voltage, Input to Output	3750	V _{rms}	
Operational Temperature	-40 to +85	°C	
Storage Temperature	-40 to +125	°C	

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Derate Linearly 1.33 mw/°C
Derate Linearly 6.67 mw/°C

Electrical absolute maximum ratings are at 25°C

Electrical Characteristics

Parameter	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics @ 25°C	· · ·					
Load Current						
Continuous ¹	-	ΙL	-	-	150	mA
Peak	t =10ms	I _{LPK}	-	-	400	
On-Resistance	I _L =150mA	R _{ON}	-	7	16	Ω
Off-State Leakage Current	V _L =60V	I _{LEAK}	-	-	1	μΑ
Switching Speeds						
Turn-On	L Em ()/ 10)/	V_{-10V} T _{ON} - 0.1	0.1	5		
Turn-Off	I _F =5mA, V _L =10V –	T _{OFF}	-	0.5	5	ms
Output Capacitance	50V; f=1MHz	C _{OUT}	-	25	-	pF
Input Characteristics @ 25°C						
Input Control Current	I _L =150mA	I _F	-	-	1	mA
Input Dropout Current	-	-	0.05	-	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μΑ
Common Characteristics @ 25°C	I					
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

¹ If both poles operate, the load current must be derated so as not to exceed the package power dissipation value.



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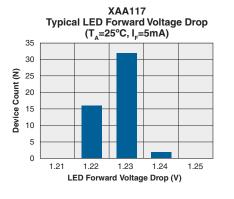
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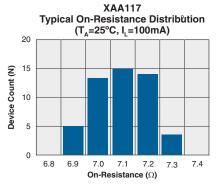
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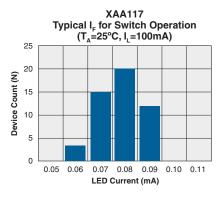
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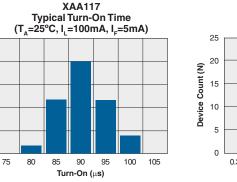
Device Count (N)

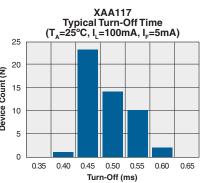
PERFORMANCE DATA*

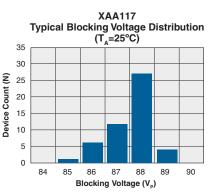


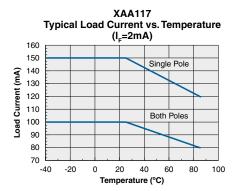


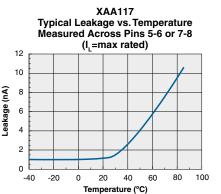


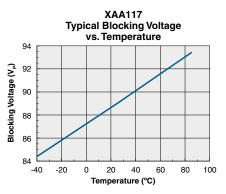


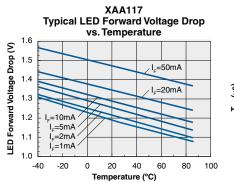


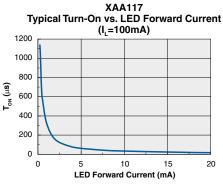


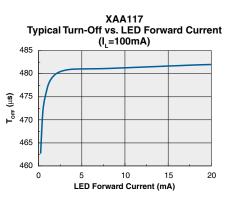








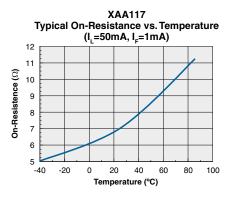


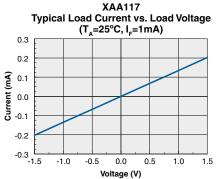


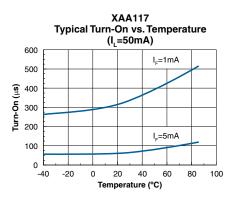
*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

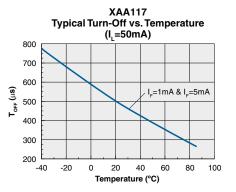


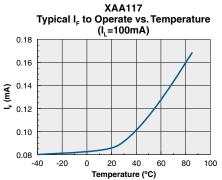
PERFORMANCE DATA*

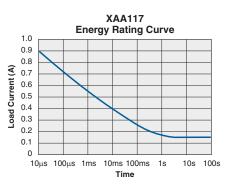


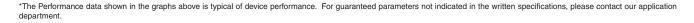














MANUFACTURING INFORMATION

Soldering

For proper assembly, the component must be processed in accordance with the current revision of IPC/JEDEC standard J-STD-020. Failure to follow the recommended guidelines may cause permanent damage to the device resulting in impaired performance and/or a reduced lifetime expectancy.

8-Pin DIP Through-Hole Package

Washing

Clare does not recommend ultrasonic cleaning or the use of chlorinated solvents.

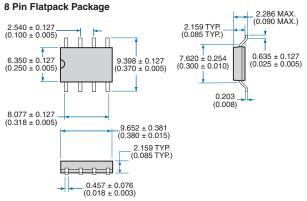


PC Board Pattern

MECHANICAL DIMENSIONS

9.652 ± 0.381 (0.380 ± 0.015) 8-0.800 DIA 7.620 ± 0.254 (0.300 ± 0.010) _2.540 ± 0.127 (0.100 ± 0.005) 2.540 ± 0.127 (0.100 ± 0.005) (8-0.031 DIA.) 9.144 TYP. (0.360 TYP.) 9.144 ± 0.508 (0.360 ± 0.020) 6.350 ± 0.127 (0.250 ± 0.005) 6.350 ± 0.127 D (0.250 ± 0.005) ŧ 7.620 ± 0.127 (0.300 ± 0.005) 0.457 ± 0.076 (0.018 ± 0.003) 3.302 (0.130) 8.077 ± 0.127 7.620 ± 0.127 (0.300 ± 0.005) 7.239 TYP. (0.285) (0.318 ± 0.005) 4.064 Typ (0.160 Typ) Dimensions 0.889 ± 0.102 mm (inches) (0.035 ± 0.004) **Recommended PCB Land Pattern** 8-Pin Surface Mount Package 4.445 ± 0.127 (0.175 ± 0.005) _9.652 ± 0.381 (0.380 ± 0.015) 0.635 ± 0.127 2.540 ± 0.127 (0.10) 3.302 (0.130) (0.025 ± 0.005) (0.100 ± 0.005) 0 \square 9.525 ± 0.254 (0.375 ± 0.010) 8.90 1.65 (0.0649) 6.350 ± 0.127 D (0.3503) (0.250 ± 0.005) 0 ł 7.620 ± 0.254 0 0 0 ┿╟ (0.300 ± 0.010) 0.457 ± 0.076 (0.018 \pm 0.003) 0.65 0.254 ± 0.127 (0.0255) 8.077 ± 0.127 (0.318 ± 0.005) (0.010 ± 0.0005)

Dimensions mm (inches)

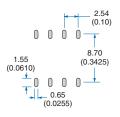


4.064 Typ (0.160 Typ)

 0.889 ± 0.102

 (0.035 ± 0.004)

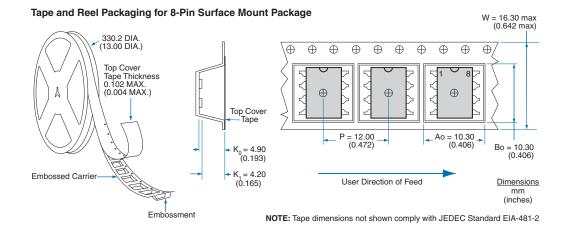
Recommended PCB Land Pattern



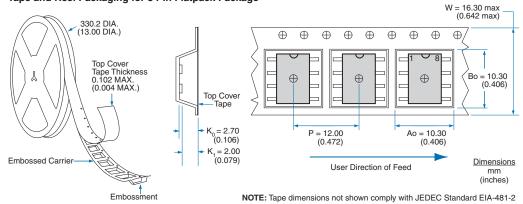
Dimensions mm (inches)



MECHANICAL DIMENSIONS



Tape and Reel Packaging for 8 Pin Flatpack Package



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